



News from Plasma-Therm
FOR IMMEDIATE RELEASE

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Plasma-Therm and Trymax Partner to Distribute Resist Ashing Products in North America

ST. PETERSBURG, Florida and NIJMEGEN, The Netherlands (Aug. 15, 2017) — Plasma-Therm LLC, and Trymax Semiconductor Equipment BV, announced today that they have entered into a distribution agreement for North America. The agreement gives Plasma-Therm the exclusive rights to distribute all of Trymax's NEO products for ashing applications.

Plasma-Therm and Trymax can now address all ashing, polymer removal and dry cleaning applications in the served markets, for all wafer sizes including 12 inches. This alliance will provide a full set of stripping technologies to customers in North America, from low temperature at 50 C to high strip rate at higher temperature.

"Partnering with Trymax allows Plasma-Therm to offer resist strip and ashing products which complement well our existing High Density Radical Flux (HDRF) technology which targets polymer removal and low damage surface treatment" commented Yannick Pilloux, business development manager at Plasma-Therm.

"The agreement with Plasma-Therm is a critical component to our North American expansion strategy," said Ludo Vandenberg, Executive Vice President of Trymax Semiconductor Equipment. "By combining forces with Plasma-Therm, we are able to better serve U.S. Front-end, MEMS and Back-end manufacturers with solutions that span the ashing and non-critical etch process steps. We are eager to get started serving our customers with the competitive advantages that our technologies can offer."

Trymax's NEO products for ashing/etching, and descum serve the semiconductor industry for 150mm, 200mm and 300mm substrates. Our bridge tools are fully flexible for processing multiple different substrate types like Si, GaAs, SiC, LiN, LiT, eWLB™ and Taiko™ wafers from R&D to high volume markets.

About Plasma-Therm

Plasma-Therm LLC is a manufacturer of leading plasma etch, deposition, and advanced packaging equipment for specialty semiconductor and nanotechnology markets. Plasma-Therm's plasma-processing and advanced-packaging solutions are used in research, pilot manufacturing, and volume production of wireless, photonics, solid state lighting, MEMS/NEMS, data storage and other devices. Learn more at <http://www.plasmatherm.com>

About Trymax

Trymax's core business is to support semiconductor manufacturers throughout the world with innovative solutions for plasma based, photoresist removal and surface cleaning, as well as isotropic etch systems that are used in the fabrication of integrated circuits and other semiconductor devices. For more information please learn more at www.trymax-semiconductor.com

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